

Lumped Composite Thermal Barrier

This example shows how to connect two 3D finite element domains through a Thermal Lumped System for heat transfer modeling.

The model is a variant of the Composite Thermal Barrier model, in which two ceramic thin layers with different thermal conductivities are sandwiched in a steel column.

Three modeling approaches are compared for the computation of the temperature distribution through the whole column. First, the composite (made of the ceramic layers) is modeled as a 3D object. In the second approach, to avoid resolving the thin domains, the Lumped Thermal System physics interface is used and coupled to the remaining domains through boundary conditions. Finally, the equivalent lumped system is simulated with a single resistor carrying the equivalent thermal resistance of the ceramic layers. In case of such simple lumped thermal system, it can be entirely encapsulated in the Thermal **Connection** feature, the Lumped Thermal System physics interface is then not required.

The methodology is useful when modeling heat transfer through thermal barriers like multilayer coatings.

GEOMETRY

This tutorial uses a simple geometry as shown in Figure 1. The cylinder has a radius of 2 cm and a height of 4 cm.

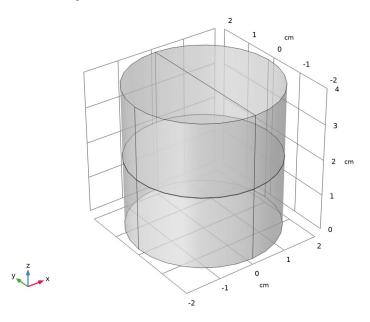


Figure 1: Geometry.

The composite consists of two layers with different thermal conductivities. The first approach resolves each layer as a 3D domain. The height of the layers is about three orders of magnitude smaller than the bulk height. This often requires to build a mesh manually to accurately resolve the thin structure.

NETWORK REPRESENTATION OF THE THERMAL SYSTEM

COMSOL Multiphysics provides the Lumped Thermal System physics interface, available from the Heat Transfer Module, and in which the **Conductive Thermal Resistor** feature allows to model conductive heat transfer without representing the underlying geometry.

The Lumped Thermal System physics interface uses a network representation of thermal systems to model heat transfer by analogy with electrical circuits. The domain and

boundary conditions for heat transfer are idealized by components joined by a network of perfectly thermally conductive wires.

This 0D approach simplifies the geometry and thus the mesh. In complex geometries, this lumped approach can reduce the amount of memory and time required for the simulation significantly.

For the modeling of the thermally resistive ceramic layers, two Conductive Thermal Resistor components are connected in a serial circuit.

In the steel column, the Heat Transfer in Solids interface is applied, and the coupling between the two physics, Heat Transfer in Solids (3D approach) and Lumped Thermal System (0D approach), is performed through the following features:

- Thermal Connection feature in the Heat Transfer in Solids interface
- External Terminal feature in the Lumped Thermal System interface

The complete thermal circuit modeled by the Lumped Thermal System interface is as shown in Figure 2.

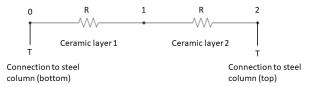


Figure 2: Thermal circuit for heat transfer in the ceramic layers.

CONDUCTIVE THERMAL RESISTOR

The Conductive Thermal Resistor feature models heat conduction in a thin shell of constant conductivity. In this example, a plane shell configuration is assumed, and the thermal resistance R (SI unit: K/W) of each layer is expressed from the thermal conductivity k (SI unit: $W/(m \cdot K)$), the thickness L (SI unit: m), and the surface area A (SI unit: m^2) as follows:

$$R = \frac{L}{kA}$$

It then assumes that the heat rate P (SI unit: W) through each layer is proportional to the temperature difference ΔT (SI unit: K) across it:

$$P = -\frac{\Delta T}{R}$$

See Theory for the Lumped Thermal System Interface in the Heat Transfer Module User's Guide for more details about the underlying theory.

In case of a lumped thermal system consisting of two serially connected resistors as presented in Figure 2, the total thermal resistance can be defined as the sum of the two resistances:

$$R_{tot} = R_1 + R_2$$

Such simple lumped systems can be directly encapsulated in the Thermal Connection feature of the Heat Transfer in Solids interface. In that case, the Lumped Thermal System physics interface is not required. This approach is demonstrated as well in the present tutorial.

MATERIAL PROPERTIES

The cylinder is made of steel. The composite consists of two layers of different ceramics.

TABLE I: CERAMICS MATERIAL PROPERTIES.

PROPERTY	CERAMIC I	CERAMIC 2
Thermal conductivity	I W/(m·K)	0.5 W/(m·K)
Density	6000 kg/m ³	5800 kg/m ³
Heat capacity at constant pressure	320 J/(kg·K)	280 J/(kg·K)

BOUNDARY CONDITIONS

The temperature at the bottom is fixed to 20°C whereas one half of the top boundary is held at 1220°C (1493 K). All other outer boundaries are perfectly insulated.

Figure 3 shows the temperature distribution in the cylinder. The composite acts as a thermal barrier resulting in a jump of the temperature over the layer.

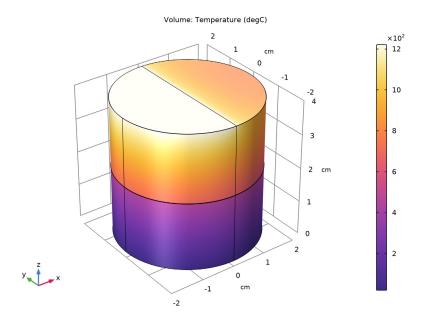


Figure 3: Temperature distribution.

Of interest is if the Lumped Thermal System approaches produce reliable results compared to resolving the thin layers in 3D. This can be done with a comparative line graph as in

Figure 4. It shows that the Lumped Thermal System approaches produce accurate results for the bulk temperatures.

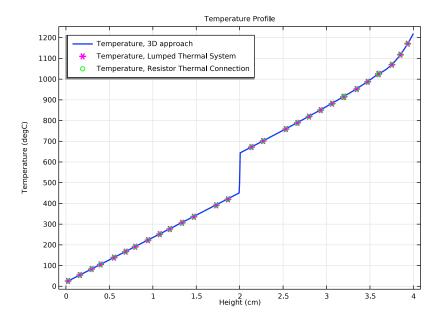


Figure 4: Temperature profile for 3D and 0D approaches.

Another important question for simulating is the influence on the mesh size and on the required RAM.

With the default tetrahedral mesh the number of mesh elements is about 130,000 elements and the meshing algorithm gives some warnings.

With the swept mesh feature you can significantly reduce the number of elements to about 2800 elements which is only 2% of the initial number of elements. In complex geometries the swept mesh algorithm may not be applicable. Using the Lumped Thermal System approach, the number of mesh elements reduces from 2800 to 2000 which is about 30% less, even in this simple geometry. You can see the number of mesh elements used in the **Messages** window below the **Graphics** window.

Notes About the COMSOL Implementation

To compare the results directly, both approaches are handled in a single MPH-file.

Application Library path: Heat_Transfer_Module/Tutorials,_Thin_Structure/ lumped_composite_thermal_barrier

Modeling Instructions

From the File menu, choose New.

NEW

In the New window, click Model Wizard.

MODEL WIZARD

- I In the Model Wizard window, click **3D**.
- 2 In the Select Physics tree, select Heat Transfer>Heat Transfer in Solids (ht).
- 3 Click Add.
- 4 Click 🔵 Study.
- 5 In the Select Study tree, select General Studies>Stationary.
- 6 Click **Done**.

GLOBAL DEFINITIONS

Parameters 1

- I In the Model Builder window, under Global Definitions click Parameters I.
- 2 In the Settings window for Parameters, locate the Parameters section.
- **3** In the table, enter the following settings:

Name	Expression	Value	Description
d_ceram1	50[um]	5E-5 m	Thickness of layer 1
d_ceram2	75[um]	7.5E-5 m	Thickness of layer 2
k_ceram1	1[W/(m*K)]	I W/(m·K)	Thermal conductivity of layer 1
k_ceram2	0.5[W/(m*K)]	0.5 W/(m·K)	Thermal conductivity of layer 2
T_hot	1220[degC]	1493.2 K	Hot temperature

GEOMETRY I

- I In the Model Builder window, under Component I (compl) click Geometry I.
- 2 In the Settings window for Geometry, locate the Units section.
- **3** From the **Length unit** list, choose **cm**.

Cylinder I (cyl1)

- I In the Geometry toolbar, click (Cylinder.
- 2 In the Settings window for Cylinder, locate the Size and Shape section.
- 3 In the Radius text field, type 2.
- 4 In the **Height** text field, type 4.
- 5 In the Geometry toolbar, click **Build All**.

Now, create thin cylinders to define the ceramic layers between the two steel domains.

Cylinder 2 (cyl2)

- I In the **Geometry** toolbar, click **Cylinder**.
- 2 In the Settings window for Cylinder, locate the Size and Shape section.
- 3 In the Radius text field, type 2.
- 4 In the Height text field, type d ceram1.
- 5 Locate the **Position** section. In the z text field, type 2-(d ceram1+d ceram2)/2.
- 6 In the Geometry toolbar, click **Build All**.

Cylinder 3 (cyl3)

- I In the Geometry toolbar, click Cylinder.
- 2 In the Settings window for Cylinder, locate the Size and Shape section.
- 3 In the Radius text field, type 2.
- 4 In the Height text field, type d ceram2.
- 5 Locate the Position section. In the z text field, type 2-(d_ceram1+d_ceram2)/2+ d ceram1.
- 6 In the Geometry toolbar, click **Build All**.

Polygon I (poll)

- I In the Geometry toolbar, click \bigoplus More Primitives and choose Polygon.
- 2 In the Settings window for Polygon, locate the Coordinates section.

3 In the table, enter the following settings:

x (cm)	y (cm)	z (cm)	
0	-2	4	
0	2	4	

4 In the Geometry toolbar, click **Build All**.

MATERIALS

Material Link I (matlnk I)

- I In the Model Builder window, under Component I (compl) right-click Materials and choose More Materials>Material Link.
- 2 In the Settings window for Material Link, locate the Link Settings section.
- 3 Click Add Material from Library.

ADD MATERIAL TO MATERIAL LINK I (MATLNKI)

- I Go to the Add Material to Material Link I (matlnkl) window.
- 2 In the tree, select Built-in>Steel AISI 4340.
- 3 Right-click and choose Add to Material Link I (matlnkl).

MATERIALS

Material Link 2 (matlnk2)

- I Right-click Materials and choose More Materials>Material Link.
- 2 In the Settings window for Material Link, locate the Geometric Entity Selection section.
- 3 Click Paste Selection.
- 4 In the Paste Selection dialog box, type 2 in the Selection text field.
- 5 Click OK.
- 6 In the Settings window for Material Link, locate the Link Settings section.
- 7 Click Blank Material.
- 8 In the Model Builder window, click Material Link 2 (matInk2).
- 9 Click Go to Material.

GLOBAL DEFINITIONS

Ceramic I

I In the Model Builder window, under Global Definitions>Materials click Material 2 (mat2).

- 2 In the Settings window for Material, type Ceramic 1 in the Label text field.
- **3** Locate the **Material Contents** section. In the table, enter the following settings:

Property	Variable	Value	Unit	Property group
Thermal conductivity	k_iso ; kii = k_iso, kij = 0	k_ceram1	W/(m·K)	Basic
Density	rho	6000	kg/m³	Basic
Heat capacity at constant pressure	Ср	320	J/(kg·K)	Basic

MATERIALS

Material Link 3 (matlnk3)

- I In the Model Builder window, under Component I (compl) right-click Materials and choose More Materials>Material Link.
- 2 In the Settings window for Material Link, locate the Geometric Entity Selection section.
- 3 Click Paste Selection.
- 4 In the Paste Selection dialog box, type 3 in the Selection text field.
- 5 Click OK.
- 6 In the Settings window for Material Link, locate the Link Settings section.
- 7 Click Blank Material.
- 8 In the Model Builder window, click Material Link 3 (matlnk3).
- 9 Click To Go to Material.

GLOBAL DEFINITIONS

Ceramic 2

- I In the Model Builder window, under Global Definitions>Materials click Material 3 (mat3).
- 2 In the Settings window for Material, type Ceramic 2 in the Label text field.
- **3** Locate the **Material Contents** section. In the table, enter the following settings:

Property	Variable	Value	Unit	Property group
Thermal conductivity	k_iso ; kii = k_iso, kij = 0	k_ceram2	W/(m·K)	Basic

Property	Variable	Value	Unit	Property group
Density	rho	5800	kg/m³	Basic
Heat capacity at constant pressure	Ср	280	J/(kg·K)	Basic

HEAT TRANSFER IN SOLIDS (HT)

Temperature I

- I In the Model Builder window, under Component I (compl) right-click Heat Transfer in Solids (ht) and choose Temperature.
- 2 Select Boundary 3 only.

Temperature 2

- I In the Physics toolbar, click **Boundaries** and choose **Temperature**.
- 2 Select Boundary 13 only.
- 3 In the Settings window for Temperature, locate the Temperature section.
- **4** In the T_0 text field, type T hot.

MESH I

First, mesh the top surface with a free triangular mesh and extrude it in layers through the cylindrical geometry. With a Distribution node, specify how many mesh layers are to be created within the domain. Resolve the composite layers with two elements in thickness.

Free Triangular 1

- I In the Mesh toolbar, click \times More Generators and choose Free Triangular.
- 2 Select Boundaries 13 and 18 only.
- 3 In the Settings window for Free Triangular, click 📳 Build Selected.

Swebt I

In the Mesh toolbar, click A Swept.

Distribution I

- I Right-click Swept I and choose Distribution.
- 2 Select Domains 2 and 3 only.
- 3 In the Settings window for Distribution, locate the Distribution section.
- 4 In the Number of elements text field, type 2.
- 5 Click III Build All.

STUDY I: 3D APPROACH

- I In the Model Builder window, right-click Study I and choose Rename.
- 2 In the Rename Study dialog box, type Study 1: 3D approach in the New label text field.
- 3 Click OK.
- 4 In the Home toolbar, click **Compute**.

RESULTS

Temperature, 3D approach

The following plot is produced by default: temperature profile on the volume as in Figure 3.

In the Settings window for 3D Plot Group, type Temperature, 3D approach in the Label text field.

Volume 1

- I In the Model Builder window, expand the Temperature, 3D approach node, then click Volume I.
- 2 In the Settings window for Volume, locate the Expression section.
- 3 From the Unit list, choose degC.
- 4 In the Temperature, 3D approach toolbar, click **1** Plot.

Create now the second model which uses the **Lumped Thermal System** interface and compare the results to the first approach.

ADD COMPONENT

In the Model Builder window, right-click the root node and choose Add Component>3D.

ADD PHYSICS

- I In the Home toolbar, click Add Physics to open the Add Physics window.
- 2 Go to the Add Physics window.
- 3 In the tree, select Heat Transfer>Heat Transfer in Solids (ht).
- **4** Find the **Physics interfaces in study** subsection. In the table, clear the **Solve** check box for **Study 1: 3D approach**.
- **5** Click **Add to Component 2** in the window toolbar.
- 6 In the tree, select Heat Transfer>Lumped Thermal System (Its).
- 7 In the table, clear the Solve check box for Study 1: 3D approach.
- **8** Click **Add to Component 2** in the window toolbar.

9 In the Home toolbar, click Add Physics to close the Add Physics window.

ADD STUDY

- I In the Home toolbar, click Add Study to open the Add Study window.
- 2 Go to the Add Study window.
- 3 Find the Studies subsection. In the Select Study tree, select General Studies>Stationary.
- 4 Find the Physics interfaces in study subsection. In the table, clear the Solve check box for Heat Transfer in Solids (ht).
- 5 Click Add Study in the window toolbar.
- **6** In the **Model Builder** window, click the root node.
- 7 In the Home toolbar, click Add Study to close the Add Study window.

GEOMETRY 2

- I In the Settings window for Geometry, locate the Units section.
- 2 From the Length unit list, choose cm.

Cylinder I (cyll)

- I Right-click Component 2 (comp2)>Geometry 2 and choose Cylinder.
- 2 In the Settings window for Cylinder, locate the Size and Shape section.
- 3 In the Radius text field, type 2.
- 4 In the Height text field, type 2-(d ceram1+d ceram2)/2.

Cylinder 2 (cyl2)

- I In the Geometry toolbar, click Cylinder.
- 2 In the Settings window for Cylinder, locate the Size and Shape section.
- 3 In the Radius text field, type 2.
- 4 In the Height text field, type 2-(d ceram1+d ceram2)/2.
- 5 Locate the Position section. In the z text field, type 2+(d_ceram1+d_ceram2)/2.
- 6 In the Geometry toolbar, click **Build All**.

Polygon I (boll)

- I In the Geometry toolbar, click \bigoplus More Primitives and choose Polygon.
- 2 In the Settings window for Polygon, locate the Coordinates section.

3 In the table, enter the following settings:

x (cm)	y (cm)	z (cm)
0	-2	4
0	2	4

4 In the Geometry toolbar, click | Build All.

MATERIALS

Material Link 4 (matlnk4)

In the Model Builder window, under Component 2 (comp2) right-click Materials and choose More Materials>Material Link.

LUMPED THERMAL SYSTEM (LTS)

In the Model Builder window, under Component 2 (comp2) click Lumped Thermal System (Its).

Ceramic I

- I In the Physics toolbar, click S Global and choose Conductive Thermal Resistor.
- 2 In the Settings window for Conductive Thermal Resistor, type Ceramic 1 in the Label text field.
- 3 Locate the Component Parameters section. From the Specify list, choose Thermal and geometric properties.
- 4 From the Material list, choose Ceramic I (mat2).
- 5 In the A text field, type $pi*(2[cm])^2$.
- **6** In the *L* text field, type d_ceram1.
- 7 Right-click Ceramic I and choose Duplicate.

Ceramic 2

- I In the Model Builder window, under Component 2 (comp2)>Lumped Thermal System (Its) click Ceramic 1.1 (R2).
- 2 In the Settings window for Conductive Thermal Resistor, type Ceramic 2 in the Label text field.
- 3 Locate the Component Parameters section. From the Material list, choose Ceramic 2 (mat3).
- 4 In the L text field, type d ceram2.

5 Locate the **Node Connections** section. In the table, enter the following settings:

Label	Node names
рl	1
p2	2

External Terminal I (term I)

- I In the Physics toolbar, click A Global and choose External Terminal.
- 2 In the Settings window for External Terminal, locate the Node Connections section.
- 3 In the Node name text field, type 0.

External Terminal 2 (term2)

- I In the Physics toolbar, click A Global and choose External Terminal.
- 2 In the Settings window for External Terminal, locate the Node Connections section.
- 3 In the Node name text field, type 2.

HEAT TRANSFER IN SOLIDS 2 (HT2)

Add Thermal Connection feature on top and bottom boundaries of the composite barrier to connect the **External Terminal** features added previously.

I In the Model Builder window, under Component 2 (comp2) click Heat Transfer in Solids 2 (ht2).

Thermal Connection 1

- I In the Physics toolbar, click A Global and choose Thermal Connection.
- 2 In the Settings window for Thermal Connection, locate the Boundary Selection, Connector I section.
- 3 Click Paste Selection.
- 4 In the Paste Selection dialog box, type 4 in the Selection text field.
- 5 Click OK.
- 6 In the Settings window for Thermal Connection, locate the Boundary Selection, Connector 2 section.
- 7 Click Paste Selection.
- **8** In the **Paste Selection** dialog box, type 7 in the **Selection** text field.
- 9 Click OK.
- 10 In the Settings window for Thermal Connection, locate the Thermal Connection section.
- II From the Connection type list, choose Lumped thermal system.

12 Find the Connector 2 subsection. From the $P_{\rm ext,2}$ list, choose External Terminal 2 (term2) (lts/term2).

Temperature I

- I In the Physics toolbar, click Boundaries and choose Temperature.
- 2 Select Boundary 3 only.

Temperature 2

- I In the Physics toolbar, click **Boundaries** and choose **Temperature**.
- 2 Select Boundary 8 only.
- 3 In the Settings window for Temperature, locate the Temperature section.
- **4** In the T_0 text field, type T_hot.

MESH 2

Free Triangular 1

- I In the Mesh toolbar, click \triangle More Generators and choose Free Triangular.
- 2 Select Boundaries 8 and 11 only.
- 3 In the Settings window for Free Triangular, click Pauld Selected.

Swept I

- I In the Mesh toolbar, click A Swept.
- 2 In the Settings window for Swept, click Build All.

STUDY 2: LUMPED THERMAL SYSTEM APPROACH

- I In the Model Builder window, right-click Study 2 and choose Rename.
- 2 In the Rename Study dialog box, type Study 2: Lumped Thermal System approach in the New label text field.
- 3 Click OK.
- 4 In the Home toolbar, click **Compute**.

RESULTS

Temperature, Lumped Thermal System approach

In the **Settings** window for **3D Plot Group**, type Temperature, Lumped Thermal System approach in the **Label** text field.

Volume 1

- I In the Model Builder window, expand the Temperature, Lumped Thermal System approach node, then click Volume 1.
- 2 In the Settings window for Volume, locate the Expression section.
- 3 From the Unit list, choose degC.

Create now the third model which represents a simplified version of the second model. It simulates the same lumped thermal system but with one single resistor of resistance R_{tot} previously defined. Such simple systems with one single resistor can be defined directly in **Thermal Connection** boundary feature. Create this model and compare the results to the previous approaches.

ADD COMPONENT

In the Model Builder window, right-click the root node and choose Add Component>3D.

ADD PHYSICS

- I In the Home toolbar, click open the Add Physics window.
- 2 Go to the Add Physics window.
- 3 In the tree, select Heat Transfer>Heat Transfer in Solids (ht).
- 4 Find the Physics interfaces in study subsection. In the table, clear the Solve check boxes for Study 1: 3D approach and Study 2: Lumped Thermal System approach.
- **5** Click **Add to Component 3** in the window toolbar.
- 6 In the Home toolbar, click and Physics to close the Add Physics window.

ADD STUDY

- I In the Home toolbar, click Add Study to open the Add Study window.
- 2 Go to the Add Study window.
- 3 Find the Studies subsection. In the Select Study tree, select General Studies>Stationary.
- 4 Find the Physics interfaces in study subsection. In the table, clear the Solve check boxes for Heat Transfer in Solids (ht), Heat Transfer in Solids 2 (ht2), and Lumped Thermal System (Its).
- **5** Click **Add Study** in the window toolbar.
- 6 In the Model Builder window, click the root node.
- 7 In the Home toolbar, click Add Study to close the Add Study window.

GEOMETRY 3

- I In the Settings window for Geometry, locate the Units section.
- 2 From the Length unit list, choose cm.

Cylinder I (cyll)

- I Right-click Component 3 (comp3)>Geometry 3 and choose Cylinder.
- 2 In the Settings window for Cylinder, locate the Size and Shape section.
- 3 In the Radius text field, type 2.
- 4 In the Height text field, type 2-(d_ceram1+d_ceram2)/2.

Cylinder 2 (cyl2)

- I In the **Geometry** toolbar, click **Cylinder**.
- 2 In the Settings window for Cylinder, locate the Size and Shape section.
- 3 In the Radius text field, type 2.
- 4 In the Height text field, type 2-(d_ceram1+d_ceram2)/2.
- 5 Locate the Position section. In the z text field, type 2+(d_ceram1+d_ceram2)/2.
- 6 In the Geometry toolbar, click **Build All**.

Polygon I (poll)

- I In the Geometry toolbar, click \bigoplus More Primitives and choose Polygon.
- 2 In the Settings window for Polygon, locate the Coordinates section.
- **3** In the table, enter the following settings:

x (cm)	y (cm)	z (cm)
0	-2	4
0	2	4

4 In the Geometry toolbar, click Build All.

MATERIALS

Material Link 5 (matlnk5)

In the Model Builder window, under Component 3 (comp3) right-click Materials and choose More Materials>Material Link.

HEAT TRANSFER IN SOLIDS 3 (HT3)

In the Model Builder window, under Component 3 (comp3) click Heat Transfer in Solids 3 (ht3).

Thermal Connection I

- I In the Physics toolbar, click Global and choose Thermal Connection.
- 2 In the Settings window for Thermal Connection, locate the Boundary Selection, Connector I section.
- 3 Click Paste Selection.
- 4 In the Paste Selection dialog box, type 4 in the Selection text field.
- 5 Click OK.
- 6 In the Settings window for Thermal Connection, locate the Boundary Selection, Connector 2 section.
- 7 Click Paste Selection.
- 8 In the Paste Selection dialog box, type 7 in the Selection text field.
- 9 Click OK.
- 10 In the Settings window for Thermal Connection, locate the Thermal Connection section.
- II From the Connection type list, choose Conductive thermal resistor.
- 12 In the R text field, type (d_ceram1/k_ceram1+d_ceram2/k_ceram2)/(pi* (2[cm])^2).

Temperature I

- I In the Physics toolbar, click **Boundaries** and choose **Temperature**.
- 2 Select Boundary 3 only.

Temperature 2

- I In the Physics toolbar, click **Boundaries** and choose **Temperature**.
- 2 Select Boundary 8 only.
- 3 In the Settings window for Temperature, locate the Temperature section.
- **4** In the T_0 text field, type T_hot.

MESH 3

Free Triangular 1

- I In the Mesh toolbar, click A More Generators and choose Free Triangular.
- 2 Select Boundaries 8 and 11 only.
- 3 In the Settings window for Free Triangular, click | Build Selected.

Swebt I

I In the Mesh toolbar, click A Swept.

2 In the Settings window for Swept, click Build All.

STUDY 3: RESISTOR THERMAL CONNECTION APPROACH

- I In the Model Builder window, right-click Study 3 and choose Rename.
- 2 In the Rename Study dialog box, type Study 3: Resistor Thermal Connection approach in the New label text field.
- 3 Click OK.
- 4 In the Home toolbar, click **Compute**.

RESULTS

Temperature, Resistor Thermal Connection approach

In the **Settings** window for **3D Plot Group**, type Temperature, Resistor Thermal Connection approach in the **Label** text field.

Volume 1

- I In the Model Builder window, expand the Temperature,
 Resistor Thermal Connection approach node, then click Volume I.
- 2 In the Settings window for Volume, locate the Expression section.
- 3 From the Unit list, choose degC.

Next, create a temperature profile along the height of the cylinder and compare the profiles from the three approaches.

Temperature Profiles

- I In the Home toolbar, click **Add Plot Group** and choose ID Plot Group.
- 2 In the Settings window for ID Plot Group, type Temperature Profiles in the Label text field.
- 3 Locate the Plot Settings section.
- 4 Select the x-axis label check box. In the associated text field, type Height (cm).
- 5 Click to expand the Title section. From the Title type list, choose Manual.
- 6 In the Title text area, type Temperature Profile.
- 7 Locate the Legend section. From the Position list, choose Upper left.
- **8** In the **Maximum relative width** text field, type **0.6**.

Line Graph 1

- I Right-click Temperature Profiles and choose Line Graph.
- **2** Select Edges 15, 17, 19, and 21 only.

- 3 In the Settings window for Line Graph, locate the Data section.
- 4 From the Dataset list, choose Study 1: 3D approach/Solution 1 (soll).
- **5** Locate the **y-Axis Data** section. In the **Expression** text field, type T.
- 6 From the Unit list, choose degC.
- 7 Locate the x-Axis Data section. From the Parameter list, choose Expression.
- **8** In the **Expression** text field, type z.
- 9 Click to expand the Coloring and Style section. From the Width list, choose 2.
- **10** Click to expand the **Legends** section. Select the **Show legends** check box.
- II From the Legends list, choose Manual.
- **12** In the table, enter the following settings:

Legends Temperature, 3D approach

Line Graph 2

- I In the Model Builder window, right-click Temperature Profiles and choose Line Graph.
- 2 In the Settings window for Line Graph, locate the Data section.
- 3 From the Dataset list, choose Study 2: Lumped Thermal System approach/ Solution 2 (3) (sol2).
- **4** Select Edges 11 and 14 only.
- **5** Locate the **y-Axis Data** section. In the **Expression** text field, type T2.
- 6 From the Unit list, choose degC.
- 7 Locate the x-Axis Data section. From the Parameter list, choose Expression.
- **8** In the **Expression** text field, type z.
- **9** Locate the **Coloring and Style** section. Find the **Line style** subsection. From the **Line** list, choose None.
- 10 From the Color list, choose Magenta.
- II Find the Line markers subsection. From the Marker list, choose Asterisk.
- 12 From the Positioning list, choose Interpolated.
- **I3** In the **Number** text field, type 30.
- 14 Locate the Legends section. Select the Show legends check box.
- 15 From the Legends list, choose Manual.

16 In the table, enter the following settings:

Legends Temperature, Lumped Thermal System

Line Graph 3

- I Right-click Temperature Profiles and choose Line Graph.
- 2 In the Settings window for Line Graph, locate the Data section.
- 3 From the Dataset list, choose Study 3: Resistor Thermal Connection approach/ Solution 3 (6) (sol3).
- **4** Select Edges 11 and 14 only.
- 5 Locate the y-Axis Data section. In the Expression text field, type T3.
- 6 From the Unit list, choose degC.
- 7 Locate the x-Axis Data section. From the Parameter list, choose Expression.
- **8** In the **Expression** text field, type z.
- 9 Locate the Coloring and Style section. Find the Line style subsection. From the Line list, choose None.
- 10 Find the Line markers subsection. From the Marker list, choose Circle.
- II From the Color list, choose Green.
- 12 From the Positioning list, choose Interpolated.
- 13 In the Number text field, type 30.
- 14 Locate the Legends section. Select the Show legends check box.
- 15 From the Legends list, choose Manual.
- **16** In the table, enter the following settings:

Legends Temperature, Resistor Thermal Connection

17 In the Temperature Profiles toolbar, click Plot.

The plot should look like that in Figure 4.